

## **PREFACE**

2013 International Conference on Mechanical Engineering and Applied Mechanics (MEAM2013) is a conference mainly focusing its center on Mechanical Engineering, Intelligent System and Applied Mechanics. The objective of the conference is to provide a forum for different researchers in different fields especially in Material field to exchange their different findings. The researchers are from different countries and in different professionals. The conference will bring all the researchers from all around the world together to share their new findings, thus to promote academic exchanging.

All the papers accepted had been passed the strict peer-review course before their publication by TTP. Here, we should show our sincere thanks to all authors for their high-quality papers and their careful presentations in the conference. At the same time, all reviewers should be thanked too for their careful work. In addition, all sponsors and all team members of TTP should be especially thanked too for their hard work and careful edition on MEAM2013.

It's the joint efforts of all different parts that they makes our conference be successful.

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